

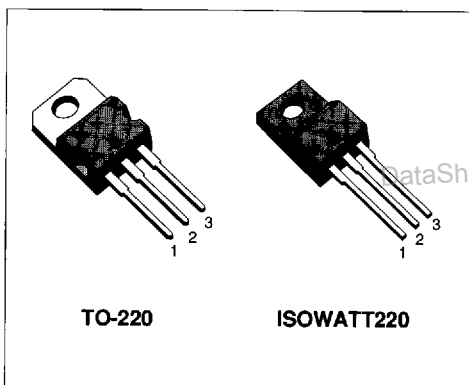
## N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTOR

TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STP5N60	600 V	< 1.6 Ω	5.6 A
STP5N60FI	600 V	< 1.6 Ω	3.2 A

- TYPICAL R<sub>DS(on)</sub> = 1.33 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- APPLICATION ORIENTED CHARACTERIZATION

### APPLICATIONS

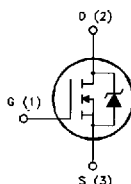
- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITCH MODE POWER SUPPLIES (SMPS)
- CHOPPER REGULATORS, CONVERTERS, MOTOR CONTROL, LIGHTING FOR INDUSTRIAL AND CONSUMER ENVIRONMENT



TO-220

ISOWATT220

### INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		Unit
		STP5N60	STP5N60FI	
V <sub>DS</sub>	Drain-source Voltage (V <sub>GS</sub> = 0)	600		V
V <sub>DGR</sub>	Drain- gate Voltage (R <sub>GS</sub> = 20 kΩ)	600		V
V <sub>GS</sub>	Gate-source Voltage	± 20		V
I <sub>D</sub>	Drain Current (continuous) at T <sub>c</sub> = 25 °C	5.6	3.2	A
I <sub>D</sub>	Drain Current (continuous) at T <sub>c</sub> = 100 °C	3.5	2	A
I <sub>DM</sub> (*)	Drain Current (pulsed)	20	20	A
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> = 25 °C	100	40	W
	Derating Factor	1	0.32	W/°C
V <sub>ISO</sub>	Insulation Withstand Voltage (DC)	2000		V
T <sub>stg</sub>	Storage Temperature	-65 to 150		°C
T <sub>j</sub>	Max. Operating Junction Temperature	150		°C

(\*) Pulse width limited by safe operating area

**THERMAL DATA**

			TO-220	ISOWATT220	
$R_{thj-case}$	Thermal Resistance Junction-case	Max	1	3.12	$^{\circ}C/W$
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max	62.5		$^{\circ}C/W$
$R_{thc-sink}$	Thermal Resistance Case-sink	Typ	0.5		$^{\circ}C/W$
$T_l$	Maximum Lead Temperature For Soldering Purpose		300		$^{\circ}C$

**AVALANCHE CHARACTERISTICS**

Symbol	Parameter	Max Value	Unit
$I_{AR}$	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max, $\delta < 1\%$ )	5.6	A
$E_{AS}$	Single Pulse Avalanche Energy (starting $T_j = 25^{\circ}C$ , $I_D = I_{AR}$ , $V_{DD} = 50V$ )	350	mJ
$E_{AR}$	Repetitive Avalanche Energy (pulse width limited by $T_j$ max, $\delta < 1\%$ )	15	mJ
$I_{AR}$	Avalanche Current, Repetitive or Not-Repetitive ( $T_C = 100^{\circ}C$ , pulse width limited by $T_j$ max, $\delta < 1\%$ )	3.5	A

**ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^{\circ}C$  unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown Voltage	$I_D = 250 \mu A$ $V_{GS} = 0$	600			V
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$ $T_c = 125^{\circ}C$			250 1000	$\mu A$ $\mu A$
$I_{GSS}$	Gate-body Leakage Current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20V$			$\pm 100$	nA

ON (\*)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 250 \mu A$	2	3	4	V
$R_{DS(on)}$	Static Drain-source On Resistance	$V_{GS} = 10V$ $I_D = 2.5A$ $V_{GS} = 10V$ $I_D = 2.5A$ $T_c = 100^{\circ}C$		1.33	1.5 3	$\Omega$ $\Omega$
$I_{D(on)}$	On State Drain Current	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $V_{GS} = 10V$	5.6			A

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$g_{fs} (*)$	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 2.5A$	1.5	3		$S$
$C_{iss}$	Input Capacitance	$V_{DS} = 25V$ $f = 1MHz$ $V_{GS} = 0$		720	1000	pF
$C_{oss}$	Output Capacitance			120	170	pF
$C_{res}$	Reverse Transfer Capacitance			50	70	pF

**SWITCHING ON**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Time	$V_{DD} = 300\text{ V}$ $I_D = 2.5\text{ A}$ $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$ (see test circuit, figure 3)		55	75	ns
$t_r$	Rise Time			150	200	ns
$(di/dt)_{on}$	Turn-on Current Slope	$V_{DD} = 480\text{ V}$ $I_D = 5\text{ A}$ $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$ (see test circuit, figure 5)		115		A/ $\mu$ s
$Q_g$	Total Gate Charge	$V_{DD} = 480\text{ V}$ $I_D = 5\text{ A}$ $V_{GS} = 10\text{ V}$		46	65	nC
$Q_{gs}$	Gate-Source Charge			8		nC
$Q_{gd}$	Gate-Drain Charge			25		nC

**SWITCHING OFF**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{r(off)}$	Off-voltage Rise Time	$V_{DD} = 480\text{ V}$ $I_D = 5\text{ A}$		80	105	ns
$t_f$	Fall Time	$R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$ (see test circuit, figure 5)		25	35	ns
$t_c$	Cross-over Time			120	160	ns

**SOURCE DRAIN DIODE**

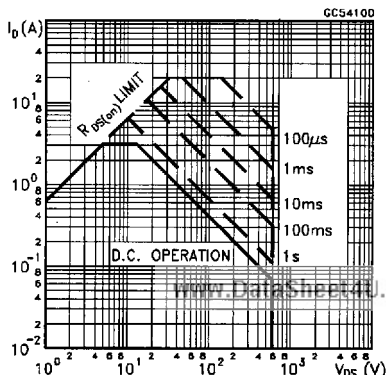
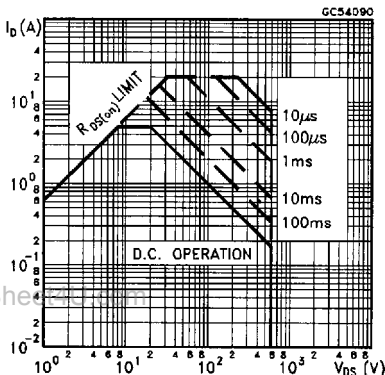
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain Current				5.6	A
$I_{SDM}(\bullet)$	Source-drain Current (pulsed)				20	A
$V_{SD}(\ast)$	Forward On Voltage	$I_{SD} = 5.9\text{ A}$ $V_{GS} = 0$			2	V
$t_{rr}$	Reverse Recovery Time	$I_{SD} = 6\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 100\text{ V}$ $T_J = 150\text{ }^\circ\text{C}$ (see test circuit, figure 5)		525		ns
$Q_{rr}$	Reverse Recovery Charge			5.8		$\mu$ C
$I_{RRM}$	Reverse Recovery Current			22		A

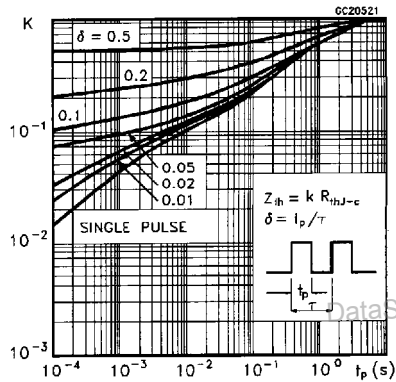
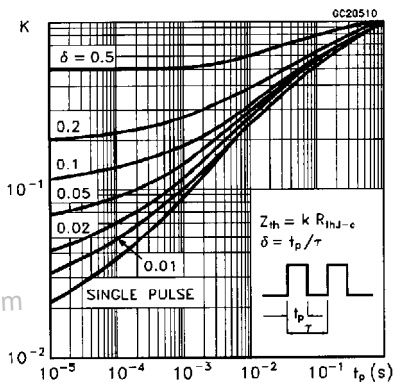
(\*) Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

( $\bullet$ ) Pulse width limited by safe operating area

**Safe Operating Areas For TO-220**

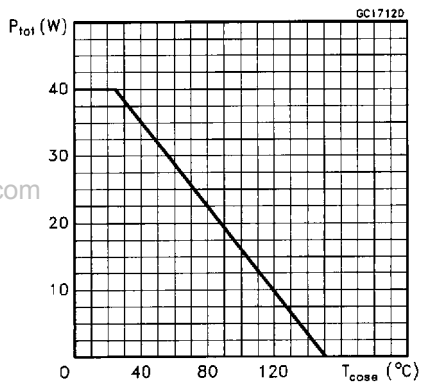
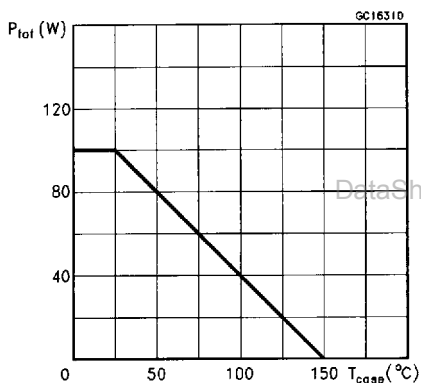
**Safe Operating Areas For ISOWATT220**





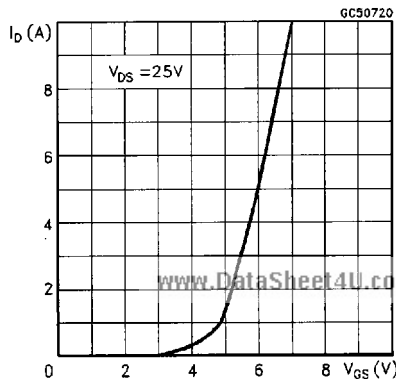
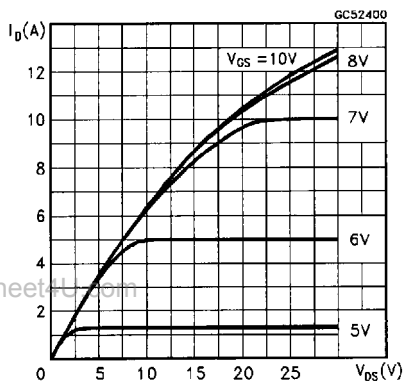
Derating Curve For TO-220

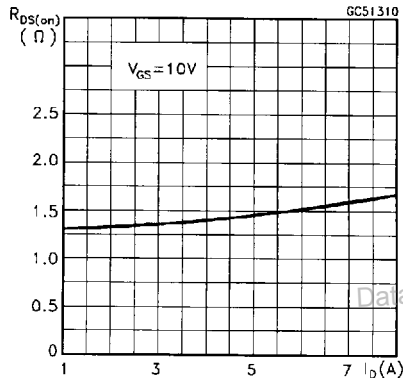
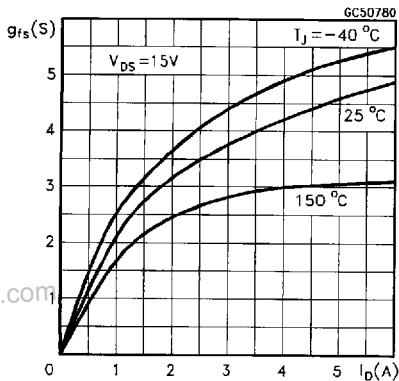
Derating Curve For ISOWATT220



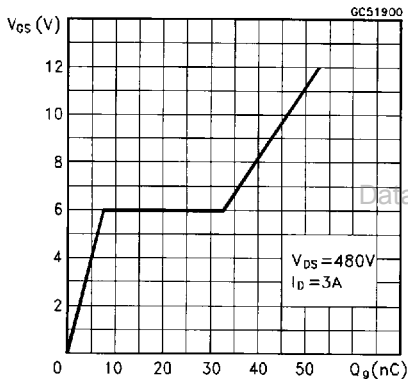
Output Characteristics

Transfer Characteristics

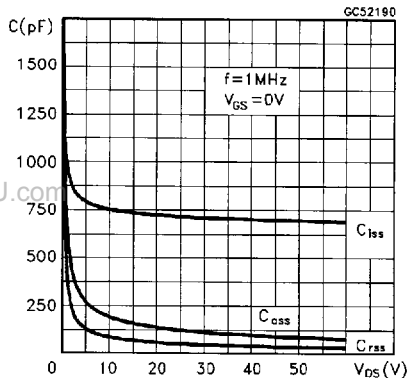




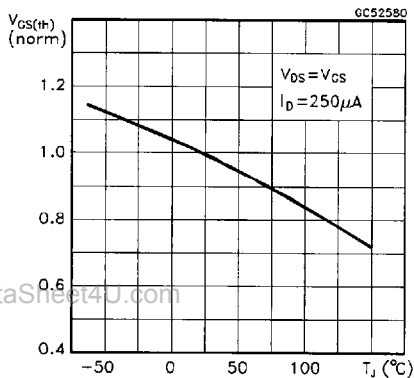
Gate Charge vs Gate-source Voltage



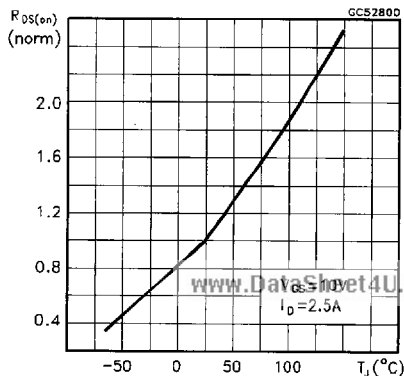
Capacitance Variations



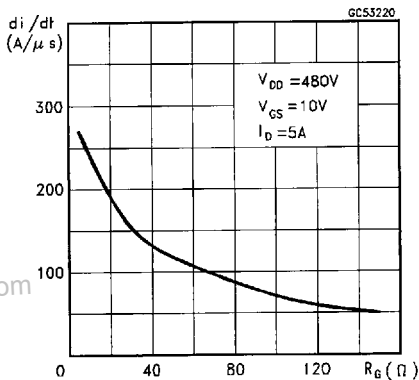
Normalized Gate Threshold Voltage vs Temperature



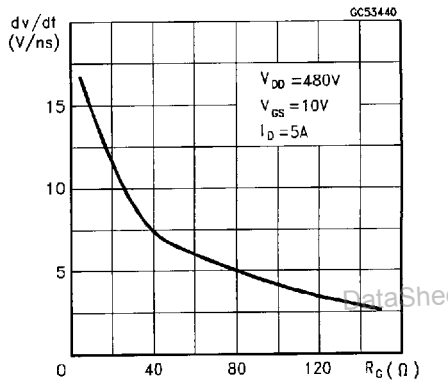
Normalized On Resistance vs Temperature



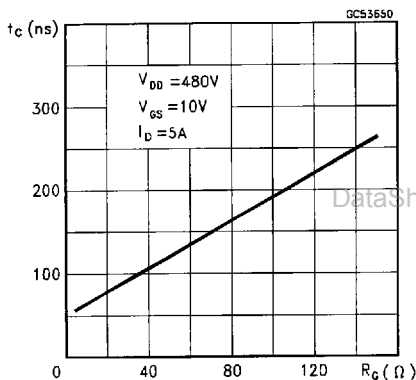
### Turn-on Current Slope



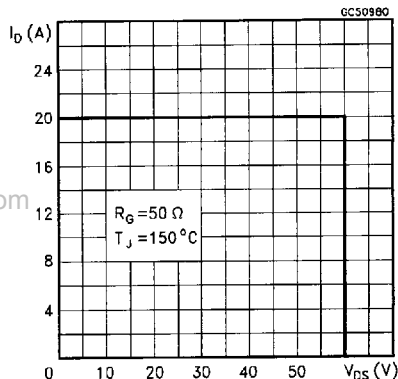
### Turn-off Drain-source Voltage Slope



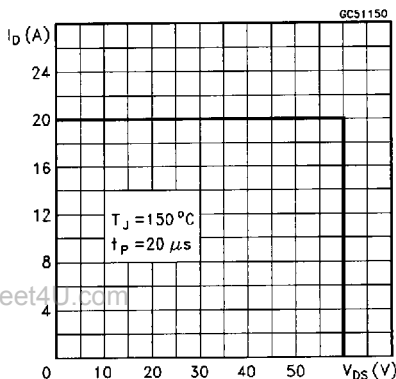
### Cross-over Time



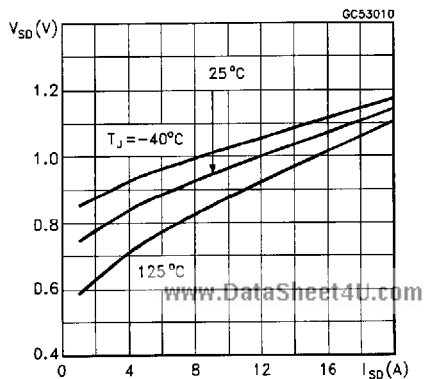
### Switching Safe Operating Area

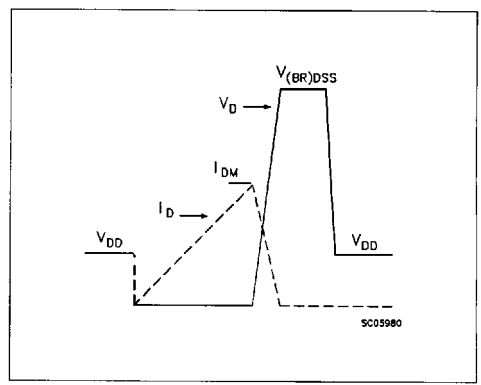
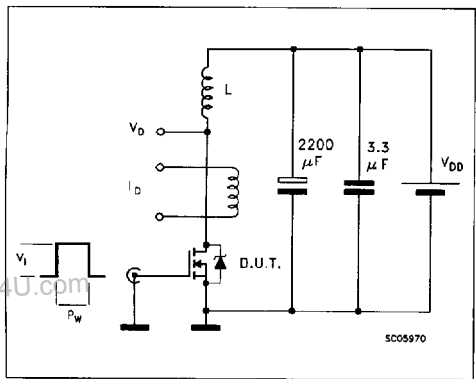


### Accidental Overload Area

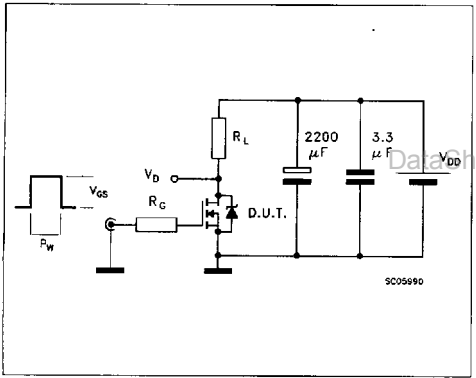


### Source-drain Diode Forward Characteristics

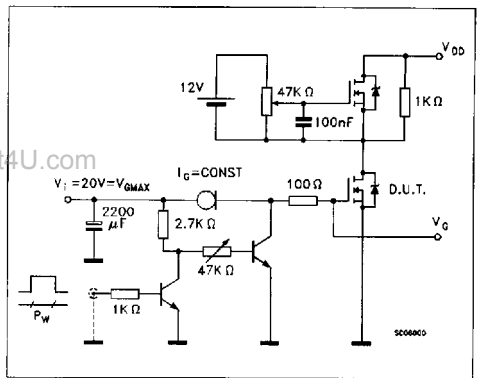




**Fig. 3: Switching Times Test Circuits For Resistive Load**



**Fig. 4: Gate Charge Test Circuit**



**Fig. 5: Test Circuit For Inductive Load Switching And Diode Reverse Recovery Time**

